

# ISL85412

Wide  $V_{IN}$  150mA Synchronous Buck Regulator

FN8378  
Rev 1.00  
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The ISL85412 is a 150mA synchronous buck regulator with an input range of 3.5V to 40V. It provides an easy to use, high efficiency low BOM count solution for a variety of applications.

The ISL85412 integrates both high-side and low-side NMOS FETs and features a PFM mode for improved efficiency at light loads. This feature can be disabled if forced PWM mode is desired. The part switches at a default frequency of 700kHz. By integrating both NMOS devices and providing internal configuration, minimal external components are required, reducing BOM count and complexity of design.

With the wide  $V_{IN}$  range and reduced BOM, the part provides an easy to implement design solution for a variety of applications while giving superior performance. It will provide a very robust design for high voltage industrial applications as well as an efficient solution for battery powered applications.

The part is available in a small Pb-free 3mmx3mm TDFN plastic package with an operation junction temperature range of -40°C to +125°C.

## Related Literature

- [AN1929](#), "ISL85413EVAL1Z, ISL85412EVAL1Z Evaluation Boards"
- [AN1931](#), "ISL85413DEMO1Z, ISL85412DEMO1Z Wide VIN Synchronous Buck Regulator - Short Form"

## Features

- Wide input voltage range of 3.5V to 40V
- Synchronous operation for high efficiency
- No compensation required
- Integrated high-side and low-side NMOS devices
- Selectable PFM or forced PWM mode at light loads
- Internal switching frequency 700kHz
- Continuous output current up to 150mA
- Internal soft-start
- Minimal external components required
- Power-good and enable functions available

## Applications

- Industrial control
- Medical devices
- Portable instrumentation
- Distributed power supplies
- Cloud infrastructure

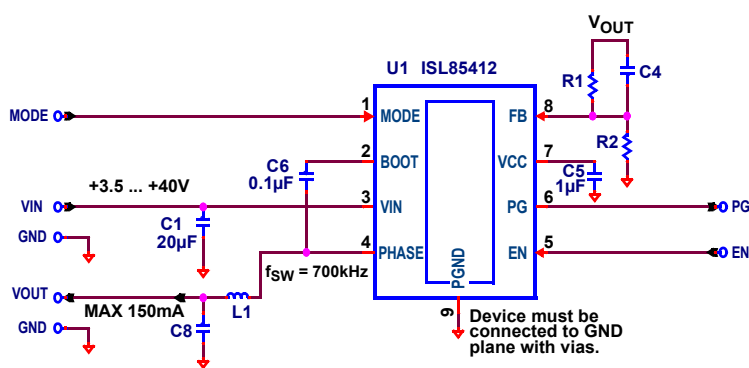


FIGURE 1. TYPICAL APPLICATION

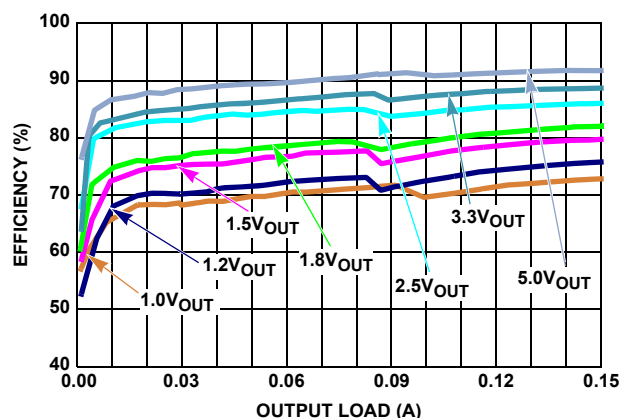


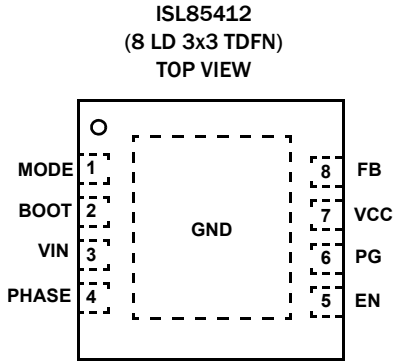
FIGURE 2. EFFICIENCY vs LOAD, PFM,  $V_{IN} = 12V$

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## Pin Configuration



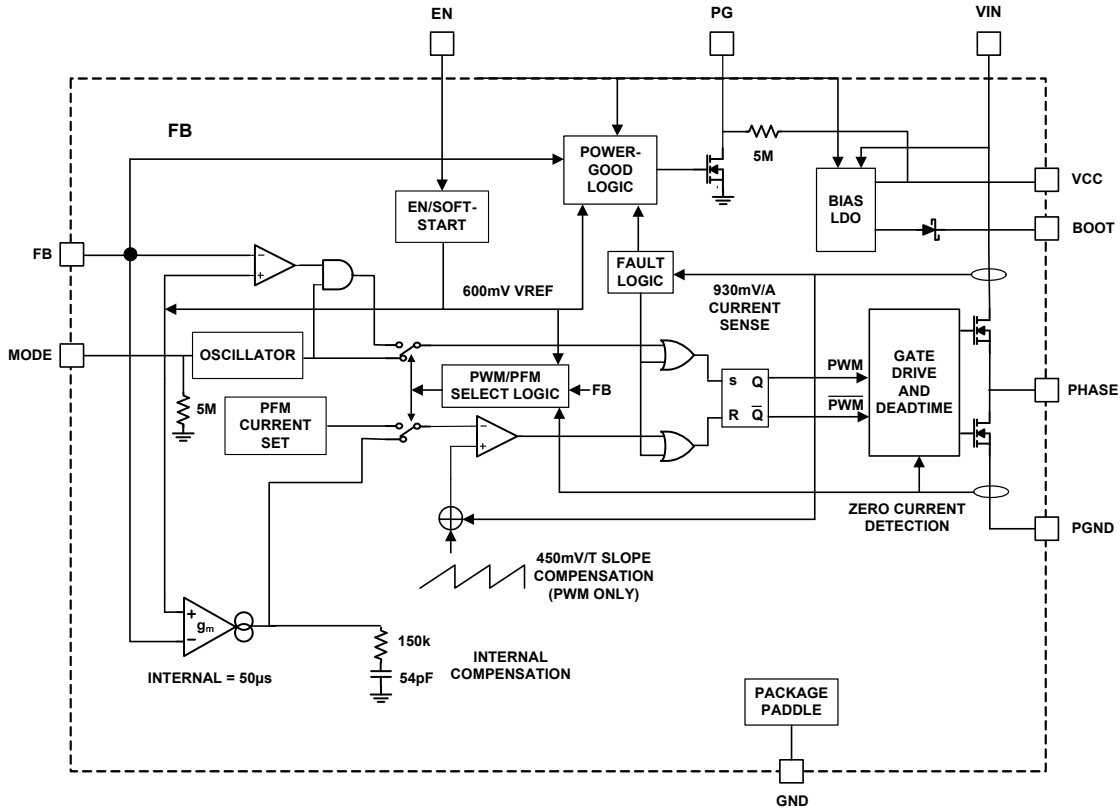
## Pin Descriptions

| PIN # | SYMBOL | PIN DESCRIPTION  |
|-------|--------|--|
| 1     | MODE   | Mode Selection pin. Connect to logic high or VCC for PWM mode. Connect to logic low or ground for PFM mode. Logic ground enables the IC to automatically choose PFM or PWM operation. There is an internal 5M $\Omega$ pull-down resistor to prevent an undefined logic state if MODE is left floating.                            |
| 2     | BOOT   | Floating bootstrap supply pin for the power MOSFET gate driver. The bootstrap capacitor provides the necessary charge to turn on the internal N-channel MOSFET. Connect an external 100nF capacitor from this pin to PHASE.  |
| 3     | VIN    | The input supply for the power stage of the regulator and the source for the internal linear bias regulator. Place a minimum of 10 $\mu$ F ceramic capacitance from VIN to GND and close to the IC for decoupling.   |
| 4     | PHASE  | Switch node output. It connects the switching FETs with the external output inductor.  |
| 5     | EN     | Regulator enable input. The regulator and bias LDO are held off when the pin is pulled to ground. When the voltage on this pin rises above 1V, the chip is enabled. Connect this pin to VIN for automatic start-up. Do not connect EN pin to VCC since the LDO is controlled by EN voltage.  |
| 6     | PG     | Open drain power-good output that is pulled to ground when the output voltage is below regulation limits or during the soft-start interval. There is an internal 5M $\Omega$ internal pull-up resistor.  |
| 7     | VCC    | Output of the internal 5V linear bias regulator. Decouple to PGND with a 1 $\mu$ F ceramic capacitor at the pin.   |
| 8     | FB     | Feedback pin for the regulator. FB is the inverting input to the voltage loop error amplifier. COMP is the output of the error amplifier. The output voltage is set by an external resistor divider connected to FB. In addition, the PWM regulator's power-good and UVLO circuits use FB to monitor the regulator output voltage. |
| EPAD  | GND    | Signal ground connections. Connect to application board GND plane with at least 5 vias. All voltage levels are measured with respect to this pin. The EPAD MUST not float.   |

TABLE 1. EXTERNAL COMPONENT SELECTION (Refer to [Figure 1](#))

| V <sub>OUT</sub><br>(V) | C <sub>4</sub><br>(pF) | C <sub>8</sub><br>( $\mu$ F) | L <sub>1</sub><br>( $\mu$ H) | R <sub>1</sub><br>(k $\Omega$ ) | R <sub>2</sub><br>(k $\Omega$ ) |
|-------------------------|------------------------|------------------------------|------------------------------|---------------------------------|---------------------------------|
| 1.0                     | 100                    | 2x22                         | 10                           | 90.9                            | 137                             |
| 1.2                     | 100                    | 2x22                         | 10                           | 90.9                            | 90.9                            |
| 1.5                     | 100                    | 2x22                         | 16                           | 90.9                            | 60.4                            |
| 1.8                     | 100                    | 2x22                         | 16                           | 90.9                            | 45.3                            |
| 2.5                     | 100                    | 22                           | 22                           | 90.9                            | 28.7                            |
| 3.3                     | 100                    | 22                           | 33                           | 90.9                            | 20.0                            |
| 5.0                     | 100                    | 22                           | 47                           | 90.9                            | 12.4                            |
| 12.0                    | 100                    | 22                           | 100                          | 90.9                            | 4.75                            |

# Functional Block Diagram



## Ordering Information

| PART NUMBER<br>(Notes 1, 2, 3) | PART MARKING        | TEMP. RANGE<br>(°C) | PACKAGE<br>(RoHS Compliant) | PKG.<br>DWG. # |
|--------------------------------|---------------------|---------------------|-----------------------------|----------------|
| ISL85412FRTZ                   | 5412                | -40 to +125         | 8 Ld TDFN                   | L8.3x3H        |
| ISL85412EVAL1Z                 | Evaluation Board    |                     |                             |                |
| ISL85412DEMO1Z                 | Demonstration Board |                     |                             |                |

**NOTES:**

1. Add "-T\*" suffix for tape and reel. Please refer to [TB347](#) for details on reel specifications.
2. These Intersil Pb-free plastic packaged products employ special Pb-free material sets, molding compounds/die attach materials, and 100% matte tin plate plus anneal (e3 termination finish, which is RoHS compliant and compatible with both SnPb and Pb-free soldering operations). Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.
3. For Moisture Sensitivity Level (MSL), please see device information page for [ISL85412](#). For more information on MSL please see techbrief [TB363](#).

## Absolute Maximum Ratings

|  |                          |
|--|--------------------------|
| VIN to GND                                       | -0.3V to +43V            |
| PHASE to GND                                     | -0.3V to VIN + 0.3V (DC) |
| PHASE to GND                                     | -2V to 44V (20ns)        |
| EN to GND  | -0.3V to +43V            |
| BOOT to PHASE                                    | -0.3V to +5.5V           |
| COMP, FS, PG, MODE, SS, VCC to GND               | -0.3V to +5.9V           |
| FB to GND  | -0.3V to +2.95V          |
| Junction Temperature Range at 0A                 | +150°C                   |
| ESD Rating                                       |                          |
| Human Body Model (Tested per JESD22-A114)        | 2.5kV                    |
| Charged Device Model (Tested per JESD22-C101E)   | 1kV                      |
| Machine Model (Tested per JESD22-A115)           | 200V                     |
| Latch-up (Tested per JESD-78A; Class 2, Level A) | 100mA                    |

**CAUTION:** Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty.

### NOTES:

- $\theta_{JA}$  is measured in free air with the component mounted on a high effective thermal conductivity test board with “direct attach” features. See Tech Brief [TB379](#) for details.
- For  $\theta_{JC}$ , the “case temp” location is the center of the exposed metal pad on the package underside.

## Thermal Information

|  |                           |                      |
|--|---------------------------|----------------------|
| Thermal Resistance                             | $\theta_{JA}$ (°C/W)      | $\theta_{JC}$ (°C/W) |
| TDFN Package ( <a href="#">Note 4, 5</a> )     | 47                        | 4                    |
| Maximum Junction Temperature (Plastic Package) | +150°C                    |                      |
| Maximum Storage Temperature Range              | -65°C to +150°C           |                      |
| Operating Junction Temperature Range           | -40°C to +125°C           |                      |
| Pb-Free Reflow Profile                         | see <a href="#">TB493</a> |                      |

## Recommended Operating Conditions

|                |                 |
|----------------|-----------------|
| Temperature    | -40°C to +125°C |
| Supply Voltage | 3.5V to 40V     |

**Electrical Specifications**  $T_J = -40^\circ\text{C}$  to  $+125^\circ\text{C}$ ,  $V_{IN} = 3.5\text{V}$  to  $40\text{V}$ , unless otherwise noted. Typical values are at  $T_A = +25^\circ\text{C}$ . **Boldface limits apply across the junction temperature range.**

| PARAMETER                             | SYMBOL | TEST CONDITIONS                               | MIN<br>( <a href="#">Note 8</a> ) | TYP         | MAX<br>( <a href="#">Note 8</a> ) | UNITS |
|---------------------------------------|--------|---|-----------------------------------|-------------|-----------------------------------|-------|
| <b>SUPPLY VOLTAGE</b>                 |        |   |                                   |             |                                   |       |
| VIN Voltage Range                     | VIN    |   | <b>3.5</b>                        |             | <b>40</b>                         | V     |
| VIN Quiescent Supply Current          | IQ     | VFB = 0.7V, MODE = 0V                         |                                   | 50          |                                   | μA    |
| VIN Shutdown Supply Current           | ISD    | EN = 0V, VIN = 40V ( <a href="#">Note 6</a> ) |                                   | 1.8         | <b>2.5</b>                        | μA    |
| VCC Voltage                           | VCC    | VIN = 40V                                     | <b>4.5</b>                        | 5.1         | <b>5.5</b>                        | V     |
|                                       |        | VIN = 12V; IOUT = 0A to 10mA                  | <b>4.35</b>                       | 5           | <b>5.45</b>                       | V     |
| <b>POWER-ON RESET</b>                 |        |   |                                   |             |                                   |       |
| VCC POR Threshold                     |        | Rising Edge                                   |                                   | 3.3         | <b>3.46</b>                       | V     |
|                                       |        | Falling Edge                                  |                                   | <b>2.76</b> | 3                                 | V     |
| <b>OSCILLATOR</b>                     |        |   |                                   |             |                                   |       |
| Nominal Switching Frequency           | fSW    | fSW = VCC                                     | <b>600</b>                        | 700         | <b>784</b>                        | kHz   |
| Minimum Off-Time                      | tOFF   | VIN = 3.5V                                    |                                   | 130         |                                   | ns    |
| Minimum On-Time                       | tON    | ( <a href="#">Note 9</a> )                    |                                   | 90          |                                   | ns    |
| <b>ERROR AMPLIFIER</b>                |        |   |                                   |             |                                   |       |
| Error Amplifier Transconductance Gain | gm     |   |                                   | 50          |                                   | μA/V  |
| FB Leakage Current                    |        | VFB = 0.6V                                    |                                   | 1           | <b>100</b>                        | nA    |
| Current Sense Amplifier Gain          | RT     |   | <b>0.84</b>                       | 0.93        | <b>1.02</b>                       | V/A   |
| FB Voltage                            |        | TA = -40°C to +125°C                          | <b>0.589</b>                      | 0.599       | <b>0.606</b>                      | V     |
| <b>POWER-GOOD</b>                     |        |   |                                   |             |                                   |       |
| Lower PG Threshold - VFB Rising       |        |   |                                   | 91          | <b>94</b>                         | %     |
| Lower PG Threshold - VFB Falling      |        |   | <b>81.5</b>                       | 85          |                                   | %     |
| Upper PG Threshold - VFB Rising       |        |   |                                   | 118         | <b>121</b>                        | %     |
| Upper PG Threshold - VFB Falling      |        |   | <b>107</b>                        | 111         |                                   | %     |
| PG Propagation Delay                  |        | Percentage of the soft-start time             |                                   | 10          |                                   | %     |
| PG Low Voltage                        |        | ISINK = 3mA, EN = VCC, VFB = 0V               |                                   | 0.05        | <b>0.3</b>                        | V     |

**Electrical Specifications**  $T_J = -40^\circ\text{C}$  to  $+125^\circ\text{C}$ ,  $V_{IN} = 3.5\text{V}$  to  $40\text{V}$ , unless otherwise noted. Typical values are at  $T_A = +25^\circ\text{C}$ . **Boldface limits apply across the junction temperature range. (Continued)**

| PARAMETER                           | SYMBOL        | TEST CONDITIONS                                   | MIN<br>(Note 8) | TYP   | MAX<br>(Note 8) | UNITS            |
|-------------------------------------|---------------|---|-----------------|-------|-----------------|------------------|
| <b>TRACKING AND SOFT-START</b>      |               |   |                 |       |                 |                  |
| Internal Soft-Start Ramp Time       |               | EN/SS = $V_{CC}$                                  | <b>1.5</b>      | 2.3   | <b>3.1</b>      | ms               |
| <b>FAULT PROTECTION</b>             |               |   |                 |       |                 |                  |
| Thermal Shutdown Temperature        | $T_{SD}$      | Rising Threshold                                  |                 | 150   |                 | $^\circ\text{C}$ |
|                                     | $T_{HYS}$     | Hysteresis  |                 | 20    |                 | $^\circ\text{C}$ |
| Current Limit Blanking Time         | $t_{OCON}$    |   |                 | 17    |                 | Clock pulses     |
| Overcurrent and Auto Restart Period | $t_{OCCOFF}$  |   |                 | 8     |                 | SS cycle         |
| Positive Peak Current Limit         | IPLIMIT       | (Note 7)  | <b>0.36</b>     | 0.4   | <b>0.44</b>     | A                |
| PFM Peak Current Limit              | $I_{PK\_PFM}$ |   | <b>0.17</b>     | 0.22  | <b>0.27</b>     | A                |
| Zero Cross Threshold                |               |   |                 | 5     |                 | mA               |
| Negative Current Limit              | INLIMIT       | (Note 7)  | <b>-0.33</b>    | -0.30 | <b>-0.27</b>    | A                |
| <b>POWER MOSFET</b>                 |               |   |                 |       |                 |                  |
| High-side                           | $R_{HDS}$     | $I_{PHASE} = 100\text{mA}$ , $V_{CC} = 5\text{V}$ |                 | 900   | <b>1300</b>     | $\text{m}\Omega$ |
| Low-side                            | $R_{LDS}$     | $I_{PHASE} = 100\text{mA}$ , $V_{CC} = 5\text{V}$ |                 | 500   | <b>800</b>      | $\text{m}\Omega$ |
| PHASE Leakage Current               |               | EN = PHASE = 0V                                   |                 | 50    | <b>300</b>      | nA               |
| PHASE Rise Time                     | $t_{RISE}$    | $V_{IN} = 40\text{V}$                             |                 | 10    |                 | ns               |
| <b>EN/MODE</b>                      |               |   |                 |       |                 |                  |
| Mode Input Threshold                |               | Rising Edge, Logic High                           |                 | 1.3   | <b>1.45</b>     | V                |
|                                     |               | Falling Edge, Logic Low                           | <b>0.4</b>      | 1.0   |                 | V                |
| EN Threshold                        |               | Rising Edge, Logic High                           |                 | 1.2   | <b>1.45</b>     | V                |
|                                     |               | Falling Edge, Logic Low                           | <b>0.4</b>      | 0.9   |                 | V                |
| EN Logic Input Leakage Current      |               | EN = 0V/40V                                       | <b>-0.5</b>     |       | <b>0.5</b>      | $\mu\text{A}$    |
| MODE Logic Input Leakage Current    |               | MODE = 0V   |                 | 10    | <b>100</b>      | nA               |
| MODE Pull-down Resistor             |               |   |                 | 5     | <b>6.15</b>     | $\text{M}\Omega$ |

## NOTES:

- Test Condition:  $V_{IN} = 40\text{V}$ , FB forced above regulation point (0.6V), no switching, and power MOSFET gate charging current not included.
- Established by both current sense amplifier gain test and current sense amplifier output test at  $I_L = 0\text{A}$ .
- Parameters with MIN and/or MAX limits are 100% tested at  $+25^\circ\text{C}$ , unless otherwise specified. Temperature limits established by characterization and are not production tested.
- Minimum On-Time required to maintain loop stability.

# Efficiency Curves $f_{SW} = 700kHz, T_A = +25^\circ C, C_{IN} = 20\mu F$

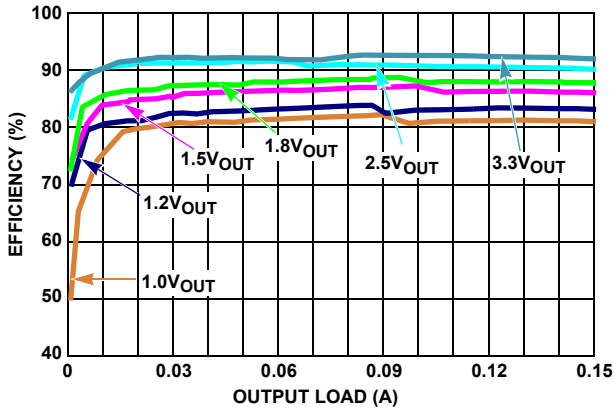


FIGURE 3. EFFICIENCY vs LOAD, PFM,  $V_{IN} = 5V$

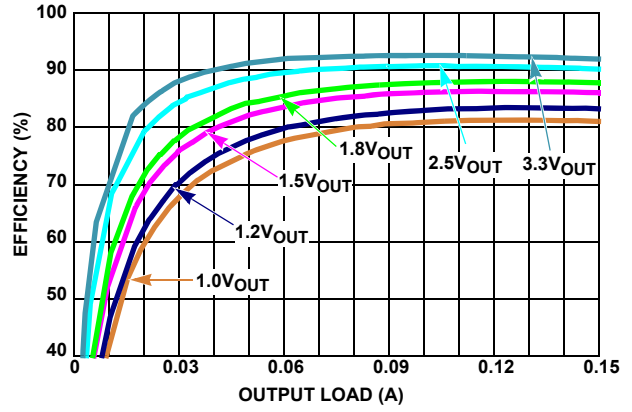


FIGURE 4. EFFICIENCY vs LOAD, PWM,  $V_{IN} = 5V$

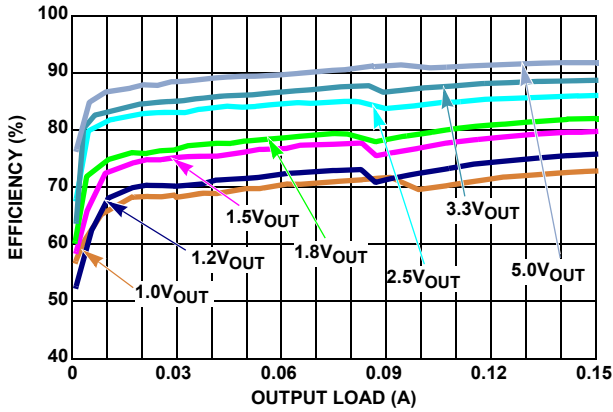


FIGURE 5. EFFICIENCY vs LOAD, PFM,  $V_{IN} = 12V$

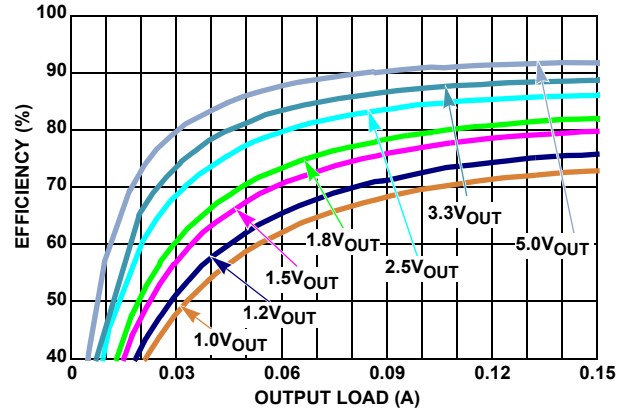


FIGURE 6. EFFICIENCY vs LOAD, PWM,  $V_{IN} = 12V$

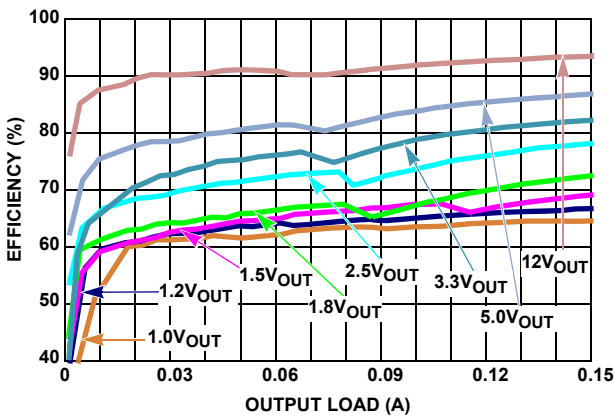


FIGURE 7. EFFICIENCY vs LOAD, PFM,  $V_{IN} = 24V$

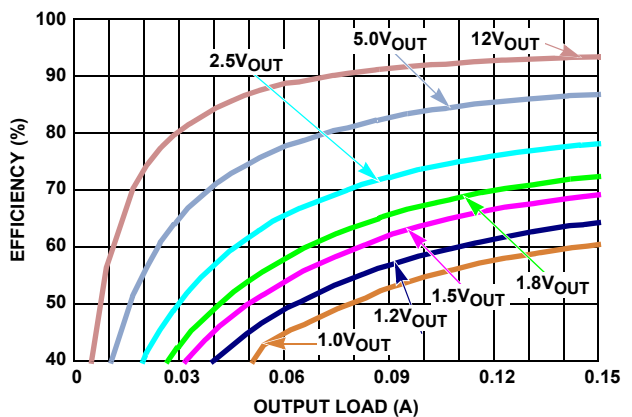


FIGURE 8. EFFICIENCY vs LOAD, PWM,  $V_{IN} = 24V$

**Efficiency Curves**  $f_{SW} = 700kHz, T_A = +25^\circ C, C_{IN} = 20\mu F$  (Continued)

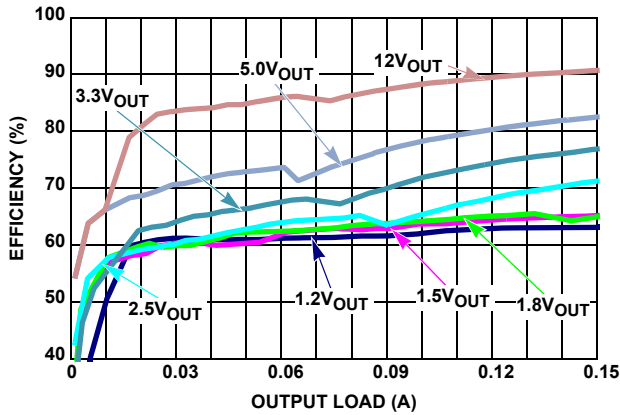


FIGURE 9. EFFICIENCY vs LOAD, PFM,  $V_{IN} = 36V$

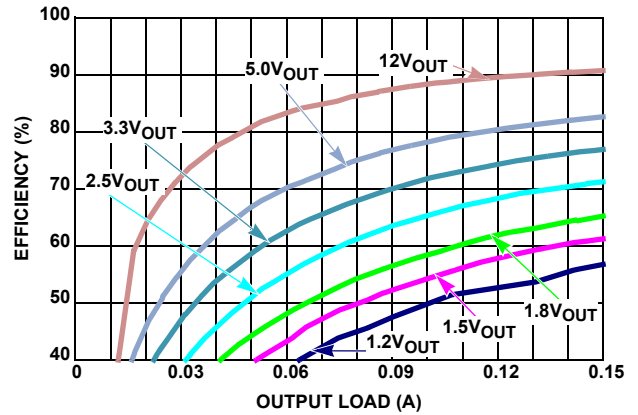


FIGURE 10. EFFICIENCY vs LOAD, PWM,  $V_{IN} = 36V$

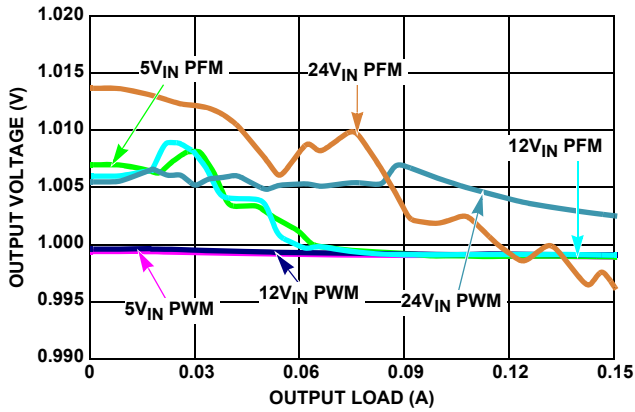


FIGURE 11.  $V_{OUT}$  REGULATION vs LOAD,  $V_{OUT} = 1V$

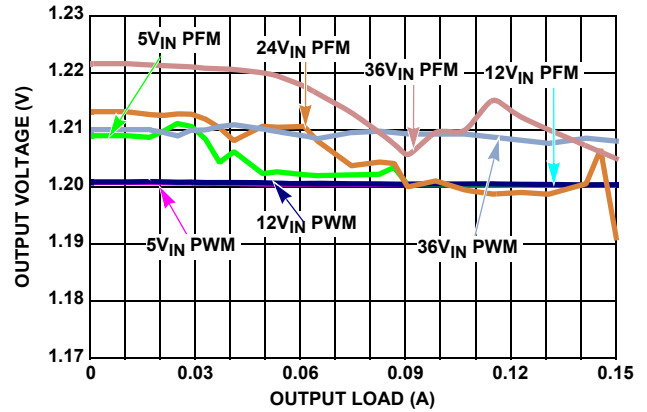


FIGURE 12.  $V_{OUT}$  REGULATION vs LOAD,  $V_{OUT} = 1.2V$

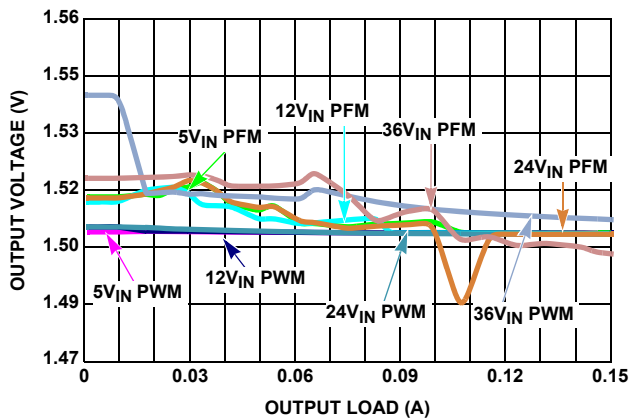


FIGURE 13.  $V_{OUT}$  REGULATION vs LOAD, PWM,  $V_{OUT} = 1.5V$

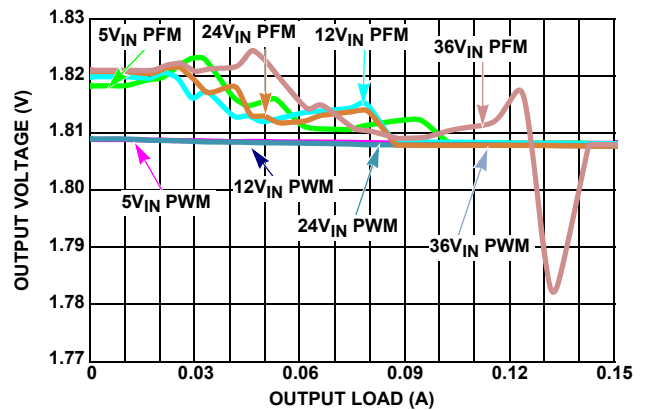


FIGURE 14.  $V_{OUT}$  REGULATION vs LOAD,  $V_{OUT} = 1.8V$



**Efficiency Curves**  $f_{SW} = 700kHz, T_A = +25^\circ C, C_{IN} = 20\mu F$  (Continued)

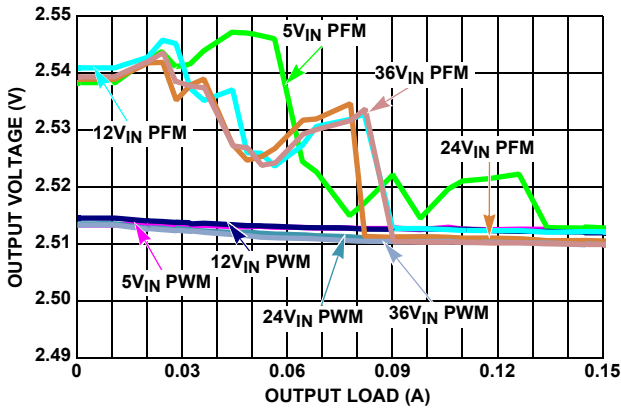


FIGURE 15.  $V_{OUT}$  REGULATION vs LOAD,  $V_{OUT} = 2.5V$

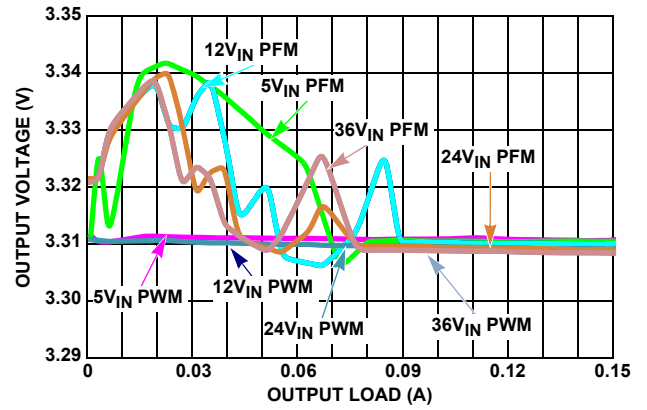


FIGURE 16.  $V_{OUT}$  REGULATION vs LOAD,  $V_{OUT} = 3.3V$

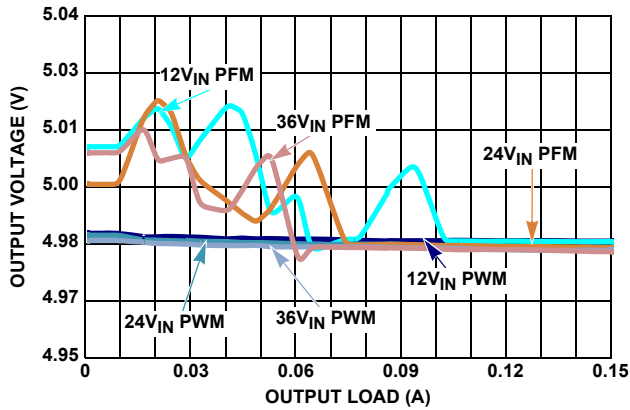


FIGURE 17.  $V_{OUT}$  REGULATION vs LOAD,  $V_{OUT} = 5V$

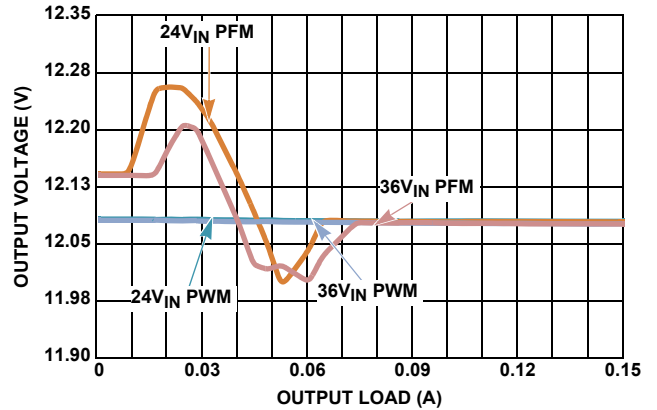


FIGURE 18.  $V_{OUT}$  REGULATION vs LOAD,  $V_{OUT} = 12V$

**Typical Performance Curves**  $V_{IN} = 12V$ ,  $V_{OUT} = 3.3V$ ,  $f_{SW} = 700kHz$ ,  $T_A = +25^\circ C$ ,  $C_{IN} = 20\mu F$ ,  $C_{OUT} = 22\mu F$ .

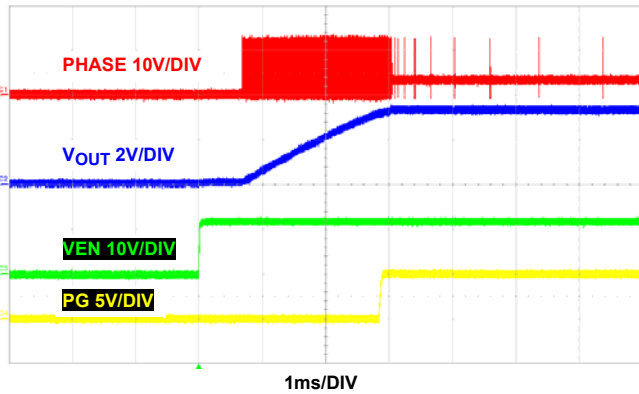


FIGURE 19. START-UP AT NO LOAD, PFM

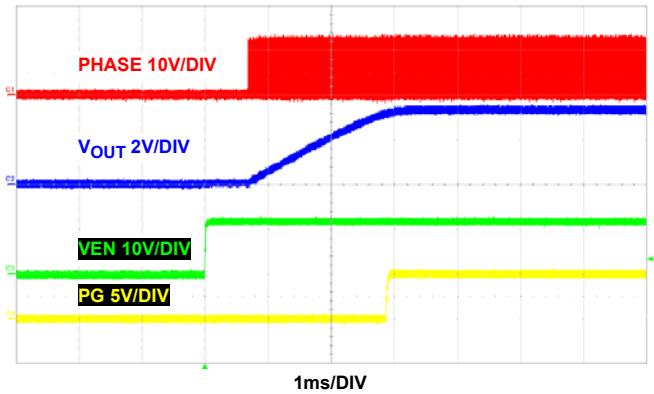


FIGURE 20. START-UP AT NO LOAD, PWM

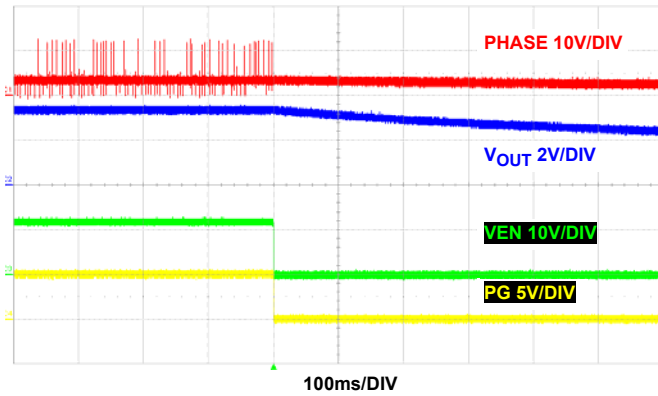


FIGURE 21. SHUTDOWN IN NO LOAD, PFM

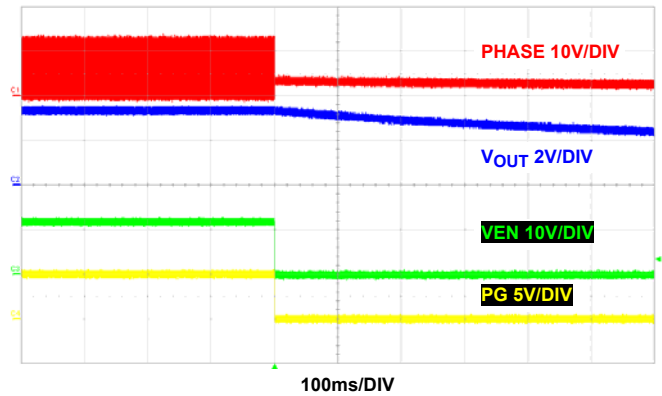


FIGURE 22. SHUTDOWN AT NO LOAD, PWM

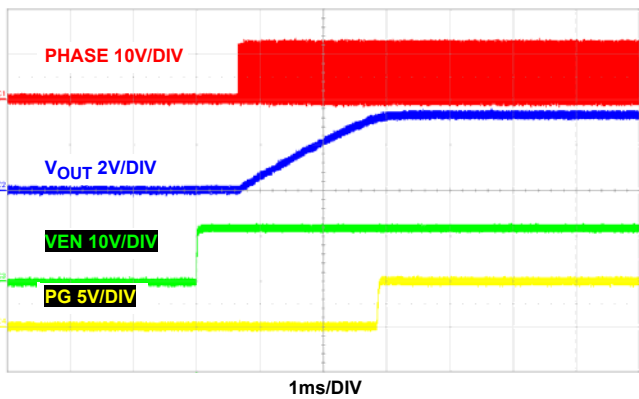


FIGURE 23. START-UP AT 150mA, PWM

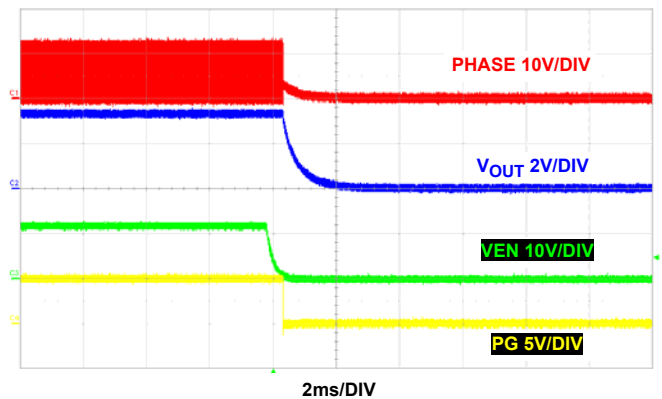


FIGURE 24. SHUTDOWN AT 150mA, PWM

**Typical Performance Curves**  $V_{IN} = 12V, V_{OUT} = 3.3V, f_{SW} = 700kHz, T_A = +25^\circ C, C_{IN} = 20\mu F,$   
 $C_{OUT} = 22\mu F.$  (Continued)

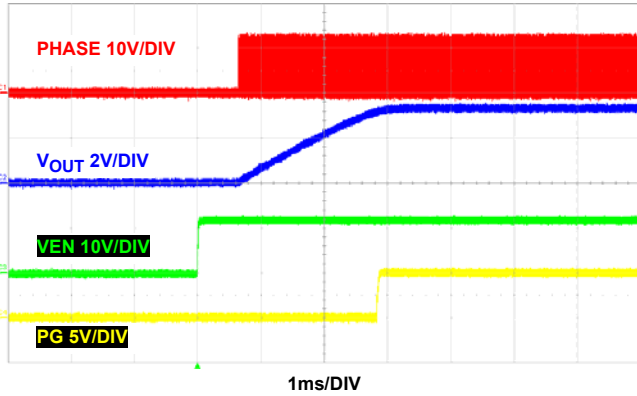


FIGURE 25. START-UP AT 150mA, PFM

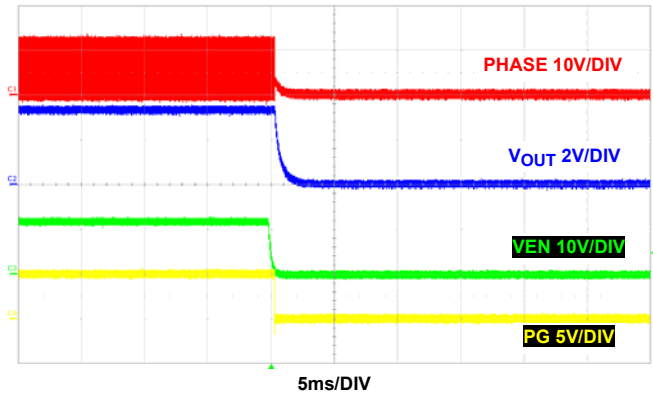


FIGURE 26. SHUTDOWN AT 150mA, PFM

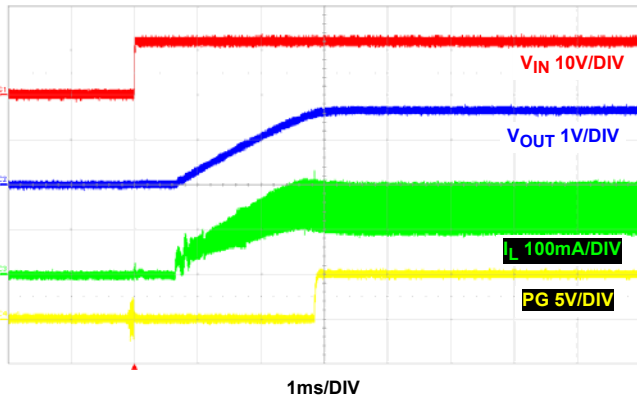


FIGURE 27. START-UP  $V_{IN}$  AT 150mA LOAD, PFM

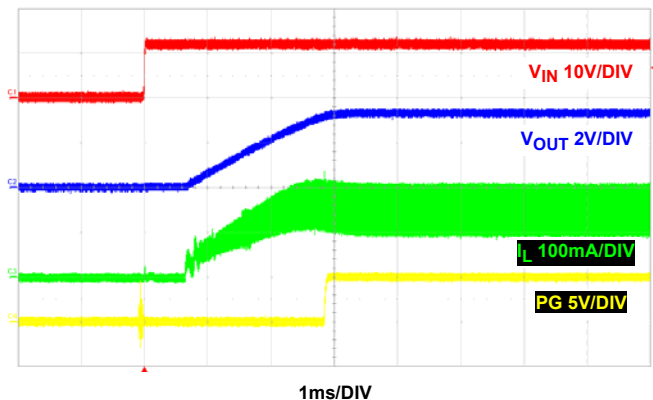


FIGURE 28. START-UP  $V_{IN}$  AT 150mA LOAD, PWM

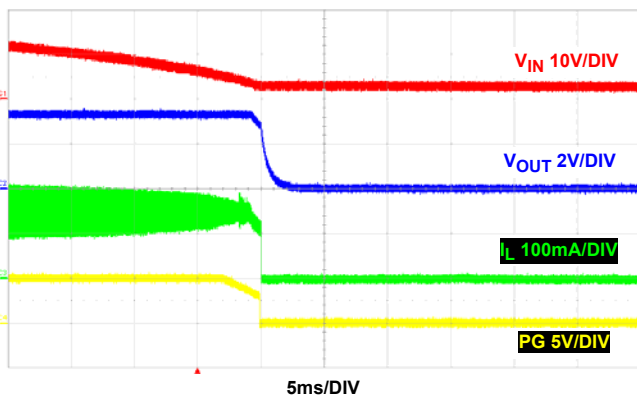


FIGURE 29. SHUTDOWN  $V_{IN}$  AT 150mA LOAD, PFM

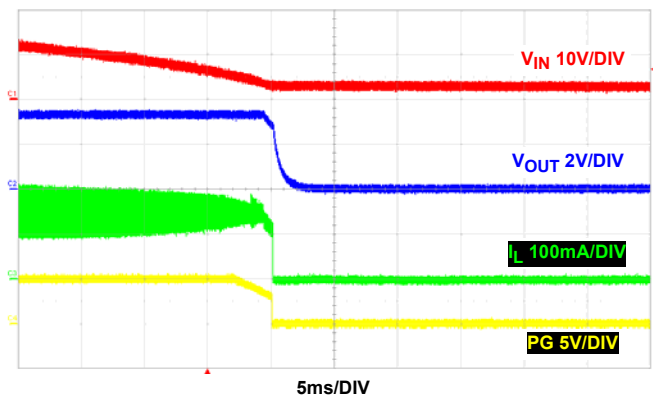


FIGURE 30. SHUTDOWN  $V_{IN}$  AT 150mA LOAD, PWM

**Typical Performance Curves**  $V_{IN} = 12V, V_{OUT} = 3.3V, f_{SW} = 700kHz, T_A = +25^\circ C, C_{IN} = 20\mu F,$   
 $C_{OUT} = 22\mu F.$  (Continued)

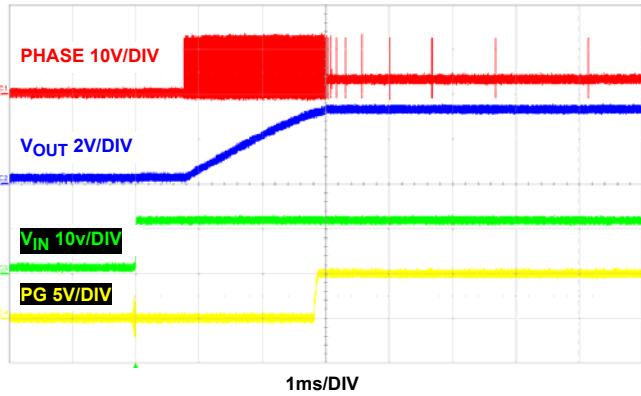


FIGURE 31. START-UP  $V_{IN}$  AT NO LOAD, PFM

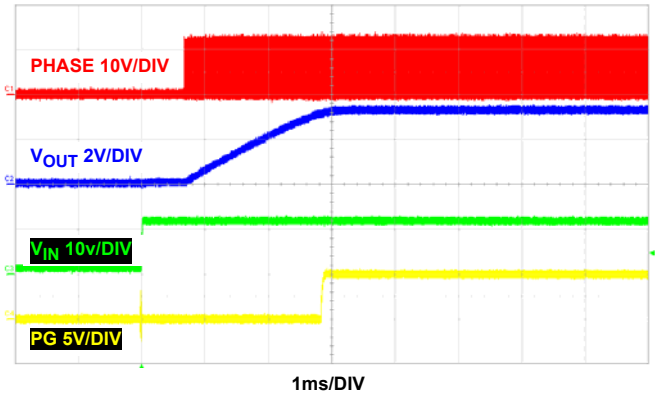


FIGURE 32. START-UP  $V_{IN}$  AT NO LOAD, PWM

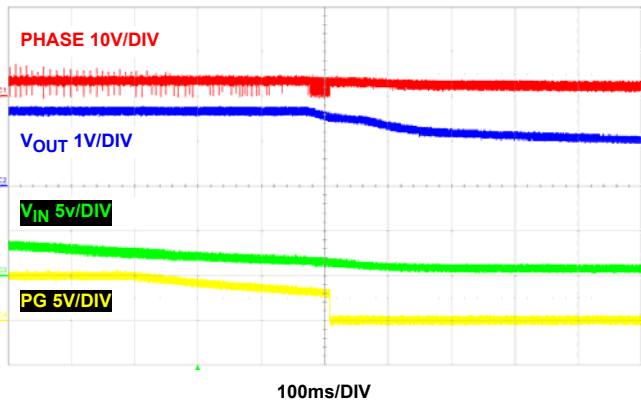


FIGURE 33. SHUTDOWN  $V_{IN}$  AT NO LOAD, PFM

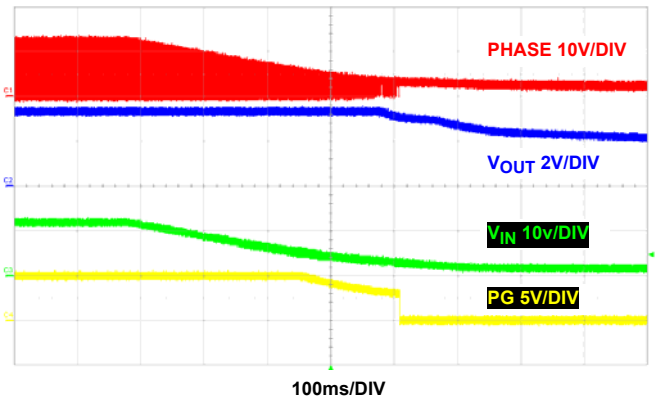


FIGURE 34. SHUTDOWN  $V_{IN}$  AT NO LOAD, PWM

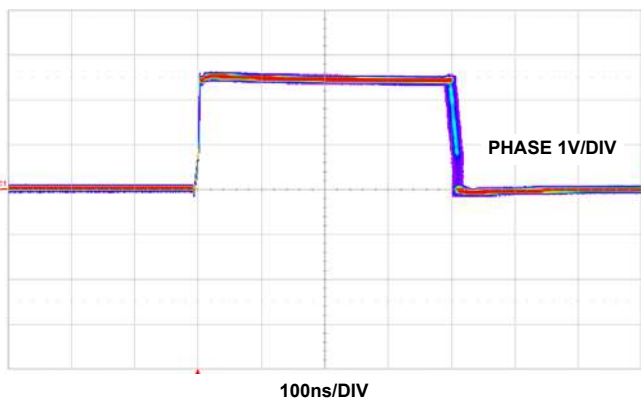


FIGURE 35. JITTER AT NO LOAD, PWM

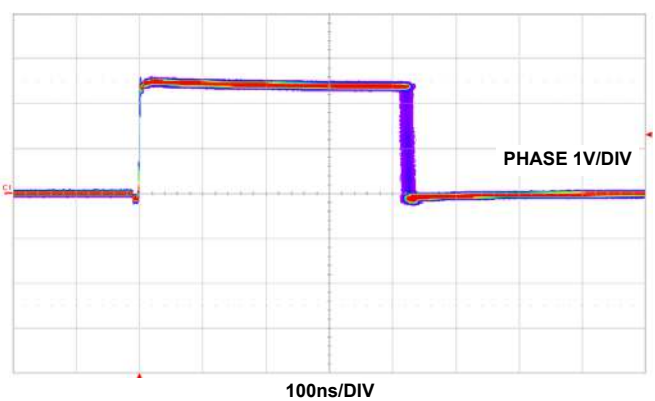


FIGURE 36. JITTER AT FULL LOAD, PWM

**Typical Performance Curves**  $V_{IN} = 12V, V_{OUT} = 3.3V, f_{SW} = 700kHz, T_A = +25^\circ C, C_{IN} = 20\mu F,$   
 $C_{OUT} = 22\mu F.$  (Continued)

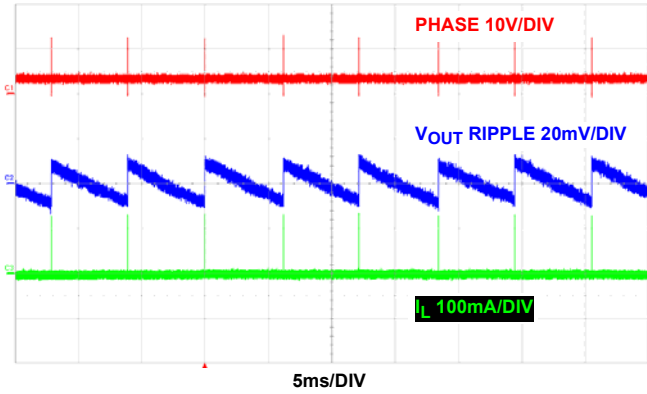


FIGURE 37. STEADY STATE AT NO LOAD, PFM

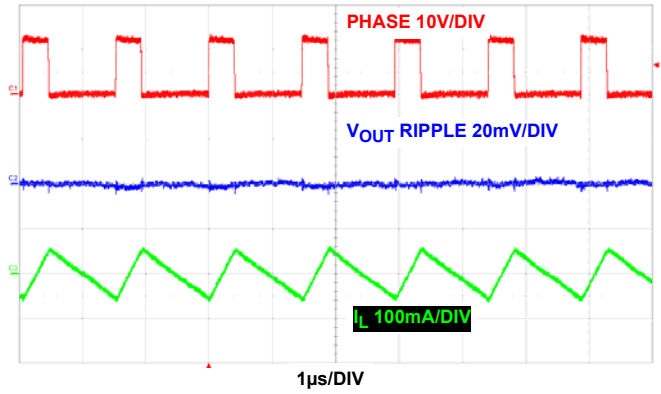


FIGURE 38. STEADY STATE AT NO LOAD, PWM

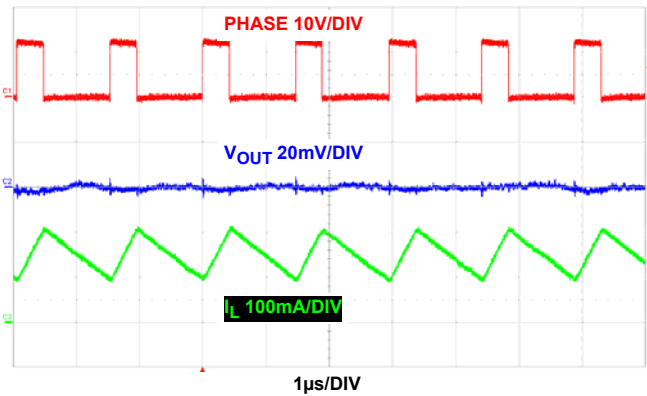


FIGURE 39. STEADY STATE AT 150mA LOAD, PWM

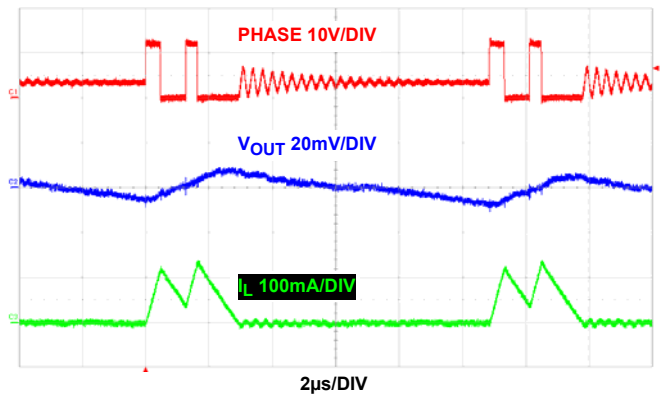


FIGURE 40. STEADY STATE AT 20mA LOAD, PFM

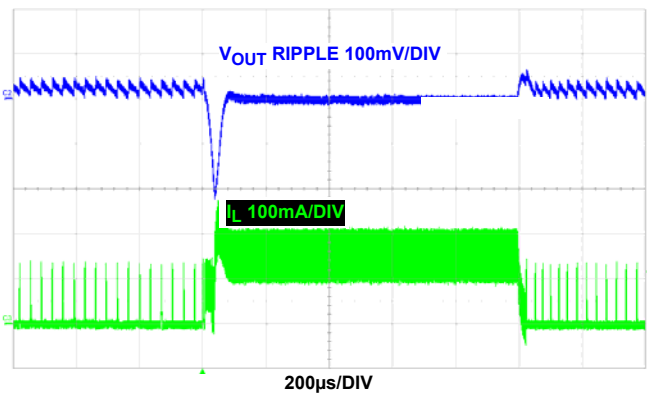


FIGURE 41. LOAD TRANSIENT, PFM

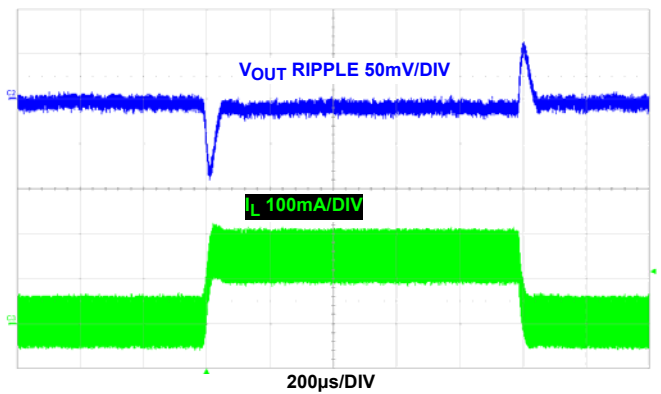


FIGURE 42. LOAD TRANSIENT, PWM

**Typical Performance Curves**  $V_{IN} = 12V, V_{OUT} = 3.3V, f_{SW} = 700kHz, T_A = +25^\circ C, C_{IN} = 20\mu F,$   
 $C_{OUT} = 22\mu F.$  (Continued)

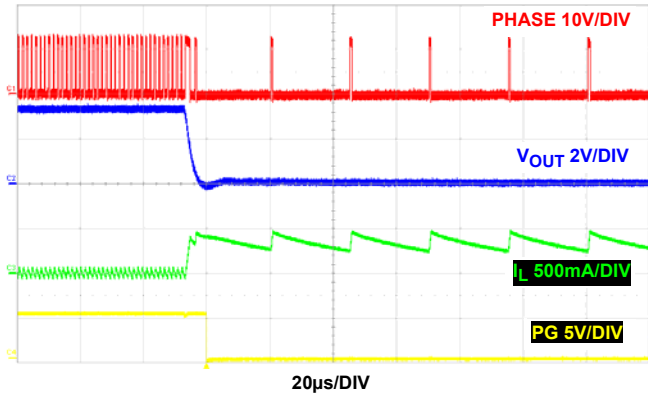


FIGURE 43. OUTPUT SHORT CIRCUIT

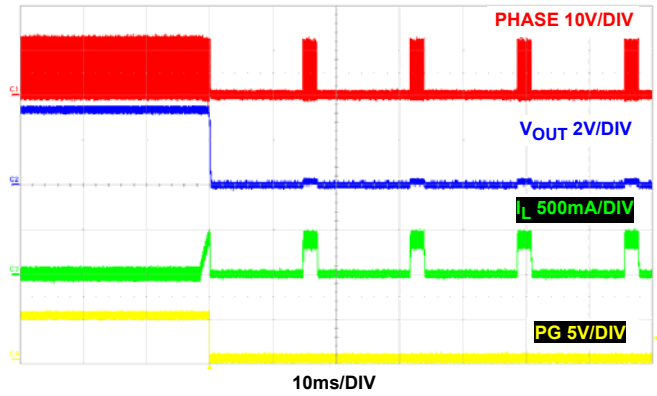


FIGURE 44. OVERCURRENT PROTECTION

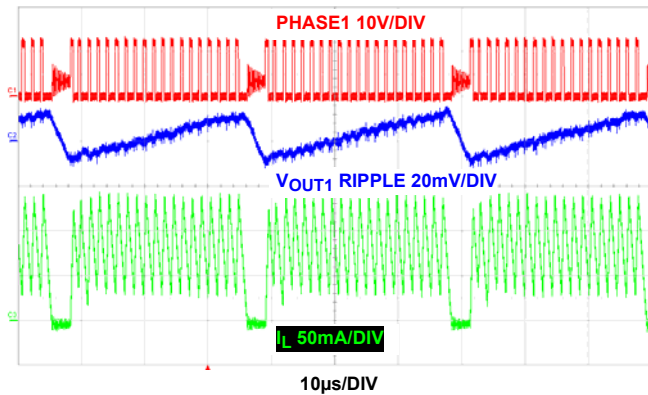


FIGURE 45. PFM TO PWM TRANSITION

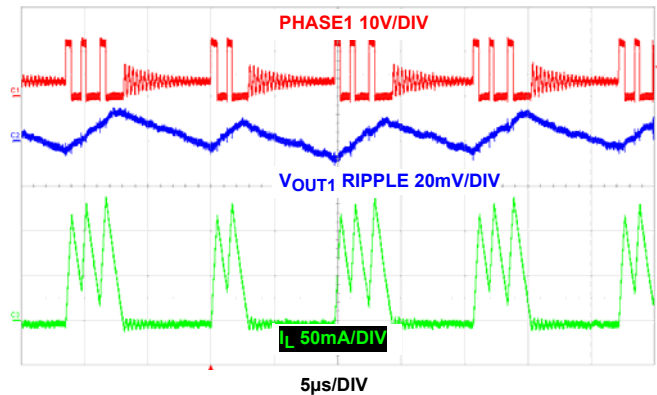


FIGURE 46. PWM TO PFM TRANSITION

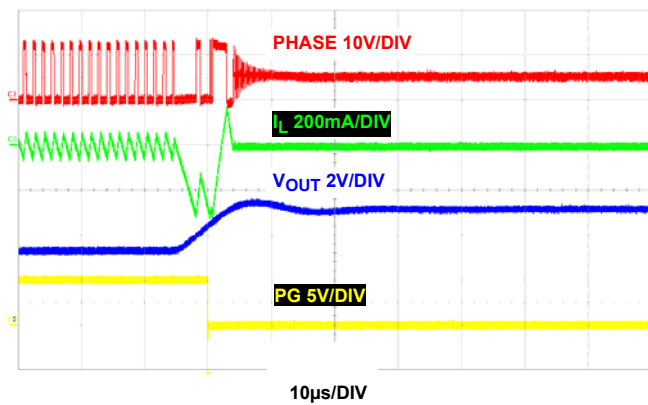


FIGURE 47. OVERVOLTAGE PROTECTION

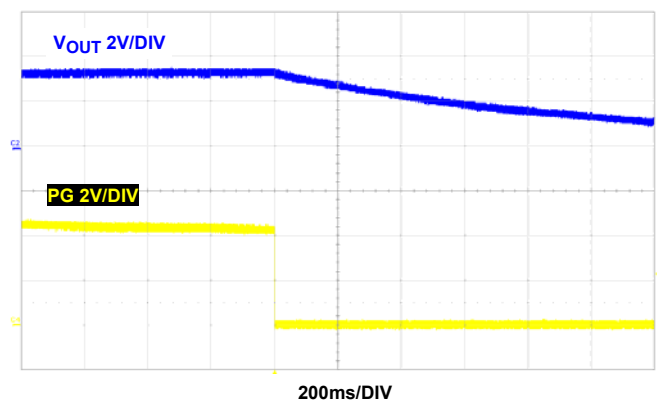


FIGURE 48. OVERTEMPERATURE PROTECTION

## Detailed Description

The ISL85412 combines a synchronous buck PWM controller with integrated power switches. The buck controller drives internal high-side and low-side N-channel MOSFETs to deliver load current up to 150mA. The buck regulator can operate from an unregulated DC source, such as a battery, with a voltage ranging from +3.5V to +40V. An internal LDO provides bias to the low voltage portions of the IC.

Peak current mode control is utilized to simplify feedback loop compensation and reject input voltage variation. User selectable internal feedback loop compensation further simplifies design. The ISL85412 switches at a default 700kHz.

The buck regulator is equipped with an internal current sensing circuit and the peak current limit threshold is typically set at 0.4A.

### Power-On Reset

The ISL85412 automatically initializes upon receipt of the input power supply and continually monitors the EN pin state. If EN is held below its logic rising threshold, the IC is held in shutdown and consumes typically 1.8 $\mu$ A from the VIN supply. If EN exceeds its logic rising threshold, the regulator will enable the bias LDO and begin to monitor the VCC pin voltage. When the VCC pin voltage clears its rising POR threshold, the controller will initialize the switching regulator circuits. If VCC never clears the rising POR threshold, the controller will not allow the switching regulator to operate. If VCC falls below its falling POR threshold while the switching regulator is operating, the switching regulator will be shut down until VCC returns.

### Soft-Start

To avoid large inrush current,  $V_{OUT}$  is slowly increased at start-up to its final regulated value in 2.3ms.

### Power-Good

PG is the open-drain output of a window comparator that continuously monitors the buck regulator output voltage via the FB pin. PG is actively held low when EN is low and during the buck regulator soft-start period. After the soft-start period completes, PG becomes high impedance provided the FB pin is within the range specified in the "Electrical Specifications" on [page 5](#). Should FB exit the specified window, PG will be pulled low until FB returns. Over-temperature faults also force PG low until the fault condition is cleared by an attempt to soft-start. There is an internal 5M $\Omega$  internal pull-up resistor.

### PWM Control Scheme

The ISL85412 employs peak current-mode pulse-width modulation (PWM) control for fast transient response and pulse-by-pulse current limiting, as shown in the "[Functional Block Diagram](#)" on [page 4](#). The current loop consists of the current sensing circuit, slope compensation ramp, PWM comparator, oscillator and latch. Current sense transresistance is typically 930mV/A and slope compensation rate,  $S_e$ , is typically 450mV/T where T is the switching cycle period. The control reference for the current loop comes from the error amplifier's output.

A PWM cycle begins when a clock pulse sets the PWM latch and the upper FET is turned on. Current begins to ramp up in the upper FET and inductor. This current is sensed ( $V_{CSA}$ ), converted to a voltage and summed with the slope compensation signal. This combined signal is compared to  $V_{COMP}$  and when the signal is equal to  $V_{COMP}$ , the latch is reset. Upon latch reset the upper FET is turned off and the lower FET turned on allowing current to ramp down in the inductor. The lower FET will remain on until the clock initiates another PWM cycle. [Figure 49](#) shows the typical operating waveforms during the PWM operation. The dotted lines illustrate the sum of the current sense and slope compensation signal.

Output voltage is regulated as the error amplifier varies its output and thus output inductor current. The error amplifier is a transconductance type and its output is terminated with a series RC (150k/54pF) network to GND. The transconductance of the error amplifier is 50 $\mu$ s. Its noninverting input is internally connected to a 600mV reference voltage and its inverting input is connected to the output voltage via the FB pin and its associated divider network.

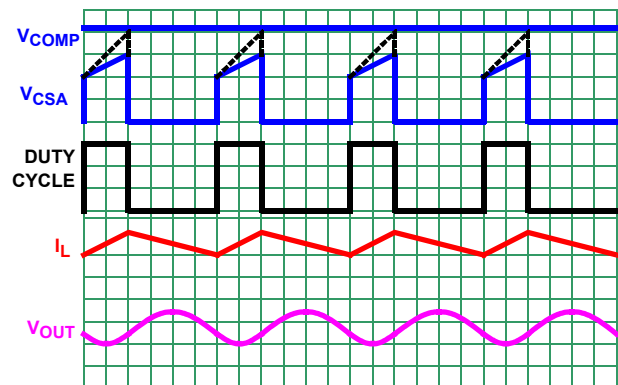


FIGURE 49. PWM OPERATION WAVEFORMS

### Light Load Operation

At light loads, converter efficiency may be improved by enabling variable frequency operation (PFM). Connecting the MODE pin to GND will allow the controller to choose such operation automatically when the load current is low. [Figure 50](#) shows the PFM operation. The IC enters the PFM mode of operation when 8 consecutive cycles of inductor current crossing zero are detected. This corresponds to a load current equal to 1/2 the peak-to-peak inductor ripple current and set by [Equation 1](#):

$$I_{OUT} = \frac{V_{OUT}(1-D)}{2Lf_{SW}} \quad (\text{EQ. 1})$$

where D = duty cycle,  $f_{SW}$  = switching frequency, L = inductor value,  $I_{OUT}$  = output loading current,  $V_{OUT}$  = output voltage.

While operating in PFM mode, the regulator controls the output voltage with a simple comparator and pulsed FET current. A comparator signals the point at which FB is equal to the 600mV reference at which time the regulator begins providing pulses of current until FB is moved above the 600mV reference by 1%. The current pulses are approximately 200mA and are issued at a frequency equal to the converter's PWM operating frequency.



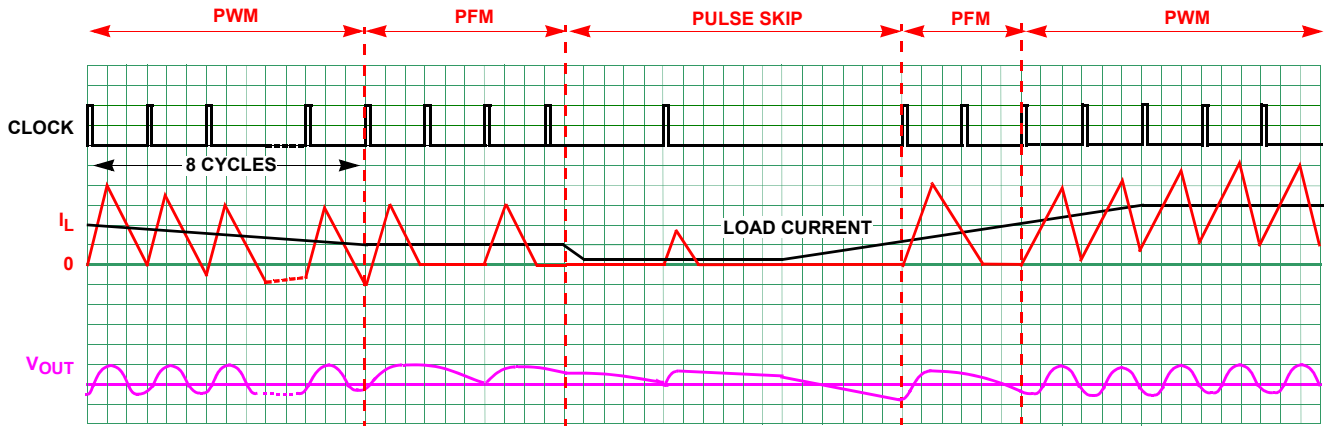


FIGURE 50. PFM MODE OPERATION WAVEFORMS

Due to the pulsed current nature of PFM mode, the converter can supply limited current to the load. Should load current rise beyond the limit,  $V_{OUT}$  will begin to decline. A second comparator signals an FB voltage 1% lower than the 600mV reference and forces the converter to return to PWM operation.

## Output Voltage Selection

The regulator output voltage is easily programmed using an external resistor divider to scale  $V_{OUT}$  relative to the internal reference voltage. The scaled voltage is applied to the inverting input of the error amplifier; refer to [Figure 51](#).

The output voltage programming resistor,  $R_2$ , depends on the value chosen for the feedback resistor,  $R_1$  and the desired output voltage,  $V_{OUT}$ , of the regulator. [Equation 2](#) describes the relationship between  $V_{OUT}$  and resistor values.

$$R_2 = \frac{R_1 \times 0.6V}{V_{OUT} - 0.6V} \quad (\text{EQ. 2})$$

If the desired output voltage is 0.6V, then  $R_2$  is left unpopulated and  $R_1$  is  $0\Omega$ .

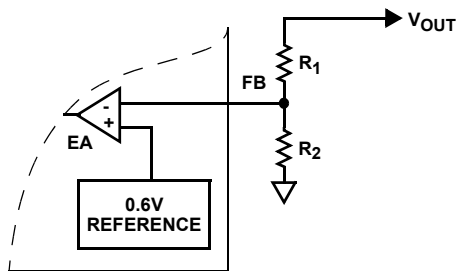


FIGURE 51. EXTERNAL RESISTOR DIVIDER

## Protection Features

The ISL85412 is protected from overcurrent, negative overcurrent and over-temperature. The protection circuits operate automatically.

### Overcurrent Protection

During PWM on-time, current through the upper FET is monitored and compared to a nominal 0.4A peak overcurrent limit. In the

event that current reaches the limit, the upper FET will be turned off until the next switching cycle. In this way, FET peak current is always well limited.

If the overcurrent condition persists for 17 sequential clock cycles, the regulator will begin its hiccup sequence. In this case, both FETs will be turned off and PG will be pulled low. This condition will be maintained for 8 soft-start periods after which the regulator will attempt a normal soft-start.

Should the output fault persist, the regulator will repeat the hiccup sequence indefinitely. There is no danger even if the output is shorted during soft-start.

If  $V_{OUT}$  is shorted very quickly, FB may collapse below  $5/8^{\text{th}}$  of its target value before 17 cycles of overcurrent are detected. The ISL85412 recognizes this condition and will begin to lower its switching frequency proportional to the FB pin voltage. This insures that under no circumstance (even with  $V_{OUT}$  near 0V) will the inductor current run away.

### Negative Current Limit

Should an external source somehow drive current into  $V_{OUT}$ , the controller will attempt to regulate  $V_{OUT}$  by reversing its inductor current to absorb the externally sourced current. In the event that the external source is low impedance, current may be reversed to unacceptable levels and the controller will initiate its negative current limit protection. Similar to normal overcurrent, the negative current protection is realized by monitoring the current through the lower FET. When the valley point of the inductor current reaches negative current limit, the lower FET is turned off and the upper FET is forced on until current reaches the positive current limit or an internal clock signal is issued. At this point, the lower FET is allowed to operate. Should the current again be pulled to the negative limit on the next cycle, the upper FET will again be forced on and current will be forced to  $1/6^{\text{th}}$  of the positive current limit. At this point the controller will turn off both FETs and wait for error amplifier's output to indicate return to normal operation. During this time, the controller will apply a  $100\Omega$  load from PHASE to PGND and attempt to discharge the output. Negative current limit is a pulse-by-pulse style operation and recovery is automatic. Negative current limit protection is disabled in PFM operating mode because reverse current is not allowed to build due to the diode emulation behavior of the lower FET.



## Over-Temperature Protection

Over-temperature protection limits maximum junction temperature in the ISL85412. When junction temperature ( $T_J$ ) exceeds  $+150^\circ\text{C}$ , both FETs are turned off and the controller waits for temperature to decrease by approximately  $20^\circ\text{C}$ . During this time PG is pulled low. When temperature is within an acceptable range, the controller will initiate a normal soft-start sequence. For continuous operation, the  $+125^\circ\text{C}$  junction temperature rating should not be exceeded.

## Boot Undervoltage Protection

If the Boot capacitor voltage falls below 1.8V, the Boot undervoltage protection circuit will turn on the lower FET for 400ns to recharge the capacitor. This operation may arise during long periods of no switching such as PFM no load situations. In PWM operation near dropout ( $V_{IN}$  near  $V_{OUT}$ ), the regulator may hold the upper FET on for multiple clock cycles. To prevent the boot capacitor from discharging, the lower FET is forced on for approximately 200ns every 34 clock cycles.

## Application Guidelines

### Simplifying the Design

[Table 1](#) on [page 3](#) provides component value selections for a variety of output voltages and will allow the designer to implement solutions with a minimum of effort.

### Output Inductor Selection

The inductor value determines the converter's ripple current. Choosing an inductor current requires a somewhat arbitrary choice of ripple current,  $\Delta I$ . A reasonable starting point is 30% of total load current. The inductor value can then be calculated using [Equation 3](#):

$$L = \frac{V_{IN} - V_{OUT}}{F_S \times \Delta I} \times \frac{V_{OUT}}{V_{IN}} \quad (\text{EQ. 3})$$

Increasing the value of inductance reduces the ripple current and thus, the ripple voltage. However, the larger inductance value may reduce the converter's response time to a load transient. The inductor current rating should be such that it will not saturate in overcurrent conditions. For typical ISL85412 applications, inductor values generally lies in the  $10\mu\text{H}$  to  $47\mu\text{H}$  range. In general, higher  $V_{OUT}$  will mean higher inductance.

### Buck Regulator Output Capacitor Selection

An output capacitor is required to filter the inductor current. The current mode control loop allows the use of low ESR ceramic capacitors and thus supports very small circuit implementations on the PC board. Electrolytic and polymer capacitors may also be used.

While ceramic capacitors offer excellent overall performance and reliability, the actual in-circuit capacitance must be considered. Ceramic capacitors are rated using large peak-to-peak voltage swings and with no DC bias. In the DC/DC converter application, these conditions do not reflect reality. As a result, the actual capacitance may be considerably lower than the advertised value. Consult the manufacturers data sheet to determine the actual in-application capacitance. Most

manufacturers publish capacitance vs DC bias so that this effect can be easily accommodated. The effects of AC voltage are not frequently published, but an assumption of  $\sim 20\%$  further reduction will generally suffice. The result of these considerations may mean an effective capacitance 50% lower than nominal and this value should be used in all design calculations. Nonetheless, ceramic capacitors are a very good choice in many applications due to their reliability and extremely low ESR.

The following equations allow calculation of the required capacitance to meet a desired ripple voltage level. Additional capacitance may be used.

For the ceramic capacitors (low ESR):

$$V_{OUT\text{ripple}} = \frac{\Delta I}{8 \times f_{SW} \times C_{OUT}} \quad (\text{EQ. 4})$$

Where  $\Delta I$  is the inductor's peak-to-peak ripple current,  $f_{SW}$  is the switching frequency and  $C_{OUT}$  is the output capacitor.

If using electrolytic capacitors then:

$$V_{OUT\text{ripple}} = \Delta I \times \text{ESR} \quad (\text{EQ. 5})$$

### Layout Considerations

Proper layout of the power converter will minimize EMI and noise and insure first pass success of the design. PCB layouts are provided in multiple formats on the Intersil web site. In addition, [Figure 52](#) will make clear the important points in PCB layout. In reality, PCB layout of the ISL85412 is quite simple.

A multi-layer printed circuit board with GND plane is recommended. [Figure 52](#) shows the connections of the critical components in the converter. Note that capacitors  $C_{IN}$  and  $C_{OUT}$  could each represent multiple physical capacitors. The most critical connections are to tie the PGND pin to the package GND pad and then use vias to directly connect the GND pad to the system GND plane. This connection of the GND pad to system plane insures a low impedance path for all return current, as well as an excellent thermal path to dissipate heat. With this connection made, place the high frequency MLCC input capacitor near the VIN pin and use vias directly at the capacitor pad to tie the capacitor to the system GND plane.

The boot capacitor is easily placed on the PCB side opposite the controller IC and 2 vias directly connect the capacitor to BOOT and PHASE.

Place a  $1\mu\text{F}$  MLCC near the VCC pin and directly connect its return with a via to the system GND plane.

Place the feedback divider close to the FB pin and do not route any feedback components near PHASE or BOOT.

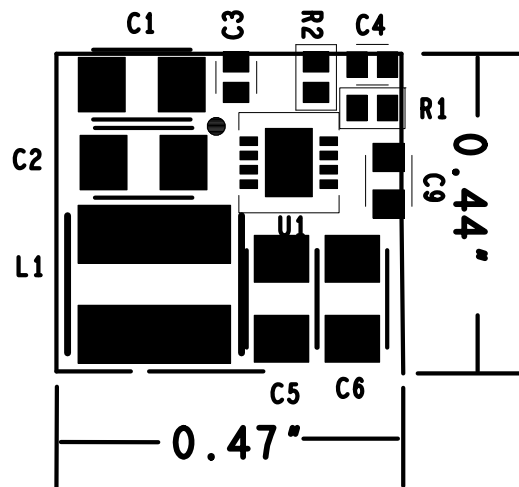


FIGURE 52. PRINTED CIRCUIT BOARD POWER PLANES AND ISLANDS

## Revision History

The revision history provided is for informational purposes only and is believed to be accurate, but not warranted. Please go to web to make sure you have the latest revision.

| DATE           | REVISION | CHANGE   |
|----------------|----------|--|
| March 13, 2015 | FN8378.1 | Upgraded the max nom VIN from 36V to 40V and abs max to 43V.<br>- On page 1 - Changed all "36V" occurrences on to "40V" and also changed "36V" to "40V" in the Typical Application diagram.<br>- On page 5 - Changed in the Abs Max Ratings: "42V" to "43V" (twice) and "43V" to "44V" (once) and in the Recommended Operating Conditions "36V" to "40V".<br>On pages 5 and 6 - In the EC table, changed "36V" to "40V" all occurrences .<br>- on page 15 - Changed the occurrence "36V" to "40V" in the "Detailed Description". |
| April 11, 2014 | FN8378.0 | Initial Release.   |

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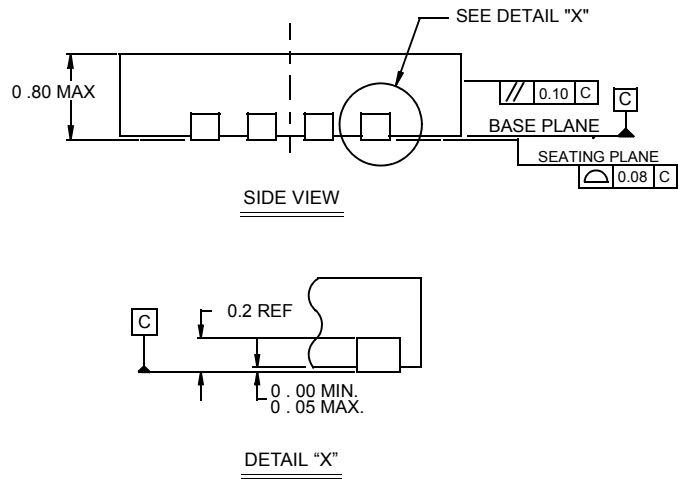
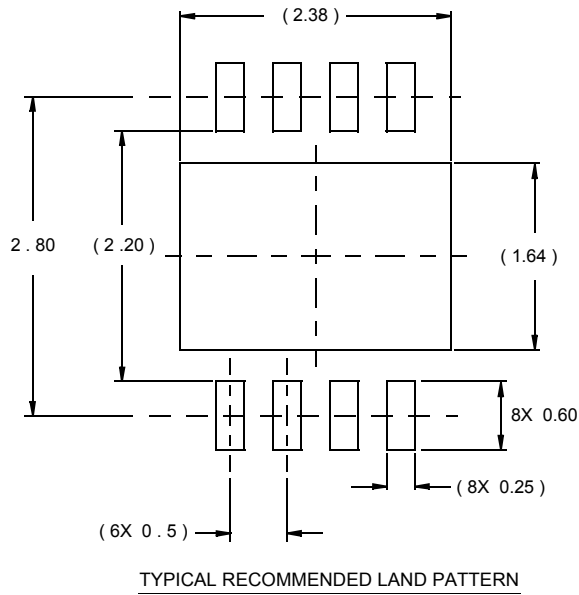
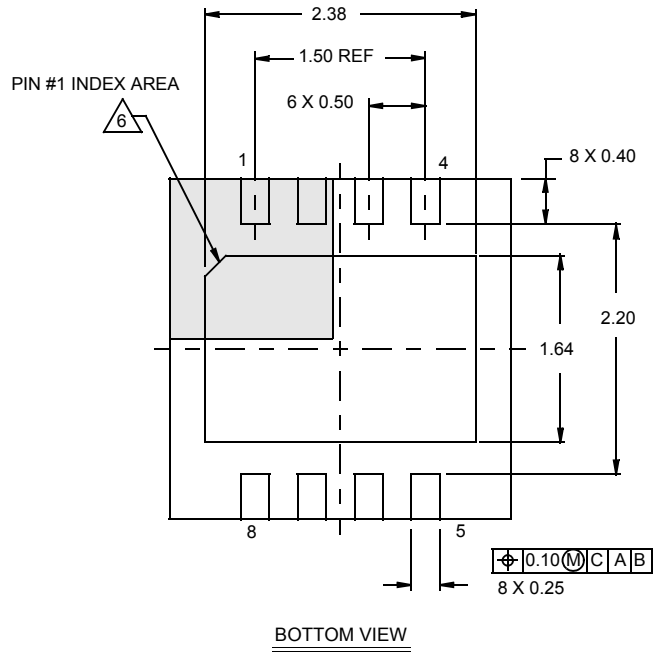
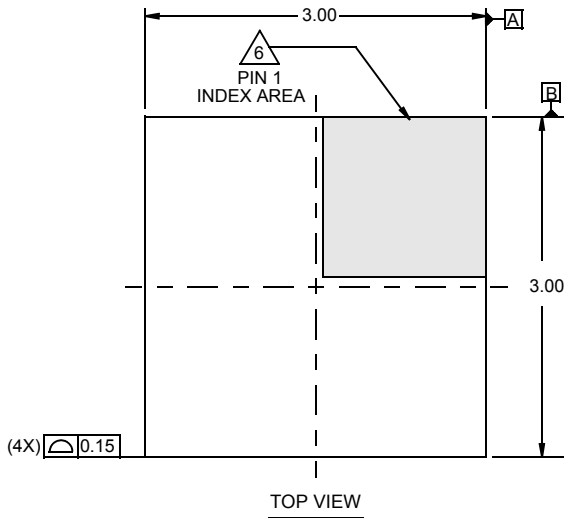
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# Package Outline Drawing

## L8.3x3H

8 LEAD THIN DUAL FLAT NO-LEAD PLASTIC PACKAGE (TDFN)

Rev 0, 2/08



NOTES:

1. Dimensions are in millimeters.  
Dimensions in ( ) for Reference Only.
2. Dimensioning and tolerancing conform to AMSE Y14.5m-1994.
3. Unless otherwise specified, tolerance : Decimal  $\pm 0.05$
4. Lead width dimension applies to the metallized terminal and is measured between 0.15mm and 0.30mm from the terminal tip.
5. Tiebar shown (if present) is a non-functional feature.
6. The configuration of the pin #1 identifier is optional, but must be located within the zone indicated. The pin #1 identifier may be either a mold or mark feature.